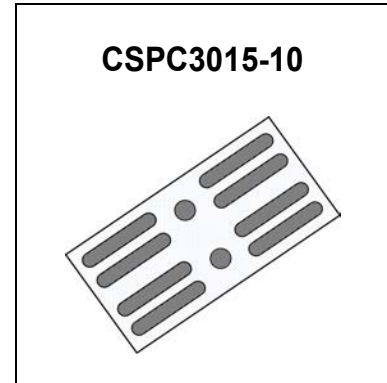




## CSP Enhancement Mode Power MOSFET

### CJ8208SP-A Dual N-Channel MOSFET

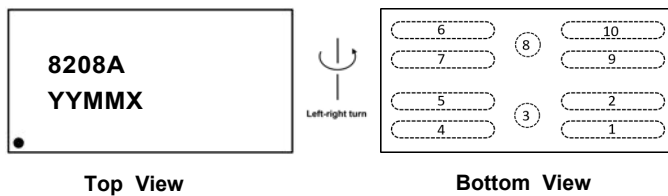
V <sub>SSS</sub>	R <sub>SS(on)</sub> TYP	I <sub>S</sub>
12V	2.1mΩ@4.5V	14A
	2.2mΩ@3.8V	
	2.5mΩ@3.1V	
	2.9mΩ@2.5V	



#### DESCRIPTION

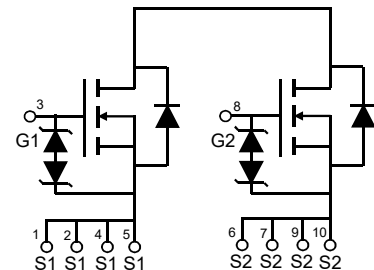
The CJ8208SP-A uses advanced trench technology to provide excellent R<sub>SS(ON)</sub>, low gate charge and operation with gate voltages as low as 2.5V while retaining a 8V V<sub>GS(MAX)</sub> rating. It is ESD protected. This device is suitable for use as a unidirectional or bi-directional load switch, facilitated by its common-drain configuration.

#### Marking and pin assignment



- Marking:
- |                        |                   |          |
|------------------------|-------------------|----------|
| 1. 8208A: Product Code | 1,2,4,5. Source1  | 3. Gate1 |
| 2. YYMMX: Date Code    | 6,7,9,10. Source2 | 8. Gate2 |
| 3. Solid dot: Pin 1    |                   |          |

#### Equivalent Circuit



#### ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Source to Source Voltage	V <sub>SSS</sub>	12	V
Gate-Source Voltage	V <sub>GSS</sub>	±8	V
Source Current(DC)	I <sub>S</sub> ①	14	A
Source Current (Pulsed)	I <sub>SP</sub> ①	140	A
Total Power Dissipation	P <sub>T</sub> ①	1.7	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 To 150	°C

# MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25\text{ }^\circ\text{C}$  unless otherwise specified

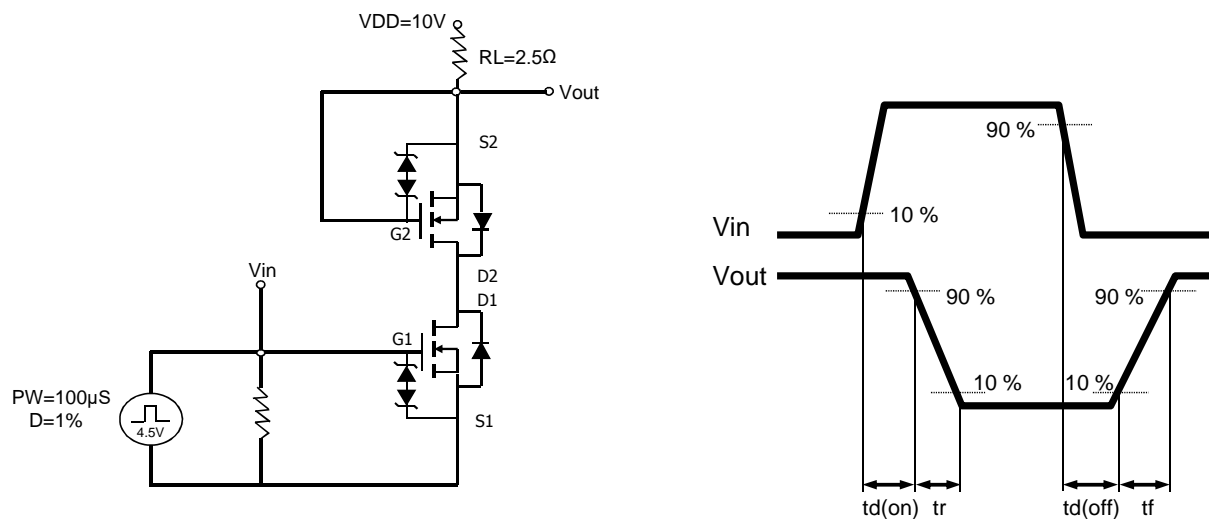
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static Parameters</b>						
Source to Source Breakdown Voltage	$BV_{SSS}$	$I_S=1\text{mA}, V_{GS}=0\text{V}$	12			V
Zero-Gate Voltage Source Current	$I_{SSS}$	$V_{SS}=12\text{V}, V_{GS}=0\text{V}$			1	$\mu\text{A}$
Gate to Source Leakage Current	$I_{GSS}$	$V_{SS}=0\text{V}, V_{GS}=\pm 8\text{V}$			$\pm 10$	$\mu\text{A}$
		$V_{SS}=0\text{V}, V_{GS}=\pm 5\text{V}$			$\pm 1$	$\mu\text{A}$
Gate to Source Threshold Voltage	$V_{TH}$	$V_{SS}=10\text{V}, I_S=1.11\text{mA}$	0.35	0.8	1.4	V
Source to Source On-state Resistance	$R_{SS(on)}$	$V_{GS}=4.5\text{V}, I_S=2\text{A}$	1.0	2.1	2.8	$\text{m}\Omega$
		$V_{GS}=3.8\text{V}, I_S=2\text{A}$	1.1	2.2	2.9	$\text{m}\Omega$
		$V_{GS}=3.1\text{V}, I_S=2\text{A}$	1.3	2.5	4.0	$\text{m}\Omega$
		$V_{GS}=2.5\text{V}, I_S=2\text{A}$	1.6	2.9	6.15	$\text{m}\Omega$
Input Capacitance	$C_{iss}$	$V_{SS}=10\text{V}, V_{GS}=0\text{V}, f=1\text{kHz}$		3530		$\text{pF}$
Output Capacitance	$C_{oss}$			855		$\text{pF}$
Reverse Transfer Capacitance	$C_{rss}$			741		$\text{pF}$
Turn-on Delay Time	$t_{d(on)}^{(3)}$	$V_{DD}=10\text{V}, R_L=2.5\Omega, V_{GS}=4.5\text{V}$		1.92		$\mu\text{s}$
Turn-on Rise Time	$t_r^{(3)}$			3.70		$\mu\text{s}$
Turn-off Delay Time	$t_{d(off)}^{(3)}$			16.6		$\mu\text{s}$
Turn-off Fall Time	$t_f^{(3)}$			11.2		$\mu\text{s}$
Total gate charge	$Q_g^{(3)}$	$V_{SS}=10\text{V}, I_S=7\text{A}, V_{GS}=6\text{V}$		59.7		$\text{nC}$
Gate1-source1 charge	$Q_{g1s1}^{(3)}$			33.1		$\text{nC}$
Gate1-source2 charge	$Q_{g1s2}^{(3)}$			15.5		$\text{nC}$
Diode Forward Voltage	$V_{F(S-S)}^{(4)}$	$V_{GS}=0\text{V}, I_S=2\text{A}$			1.3	V

Notes: 1. Mounted on FR4 board (25.4mm×25.4mm×1.0mm) using the minimum recommended pad size (36um Copper).

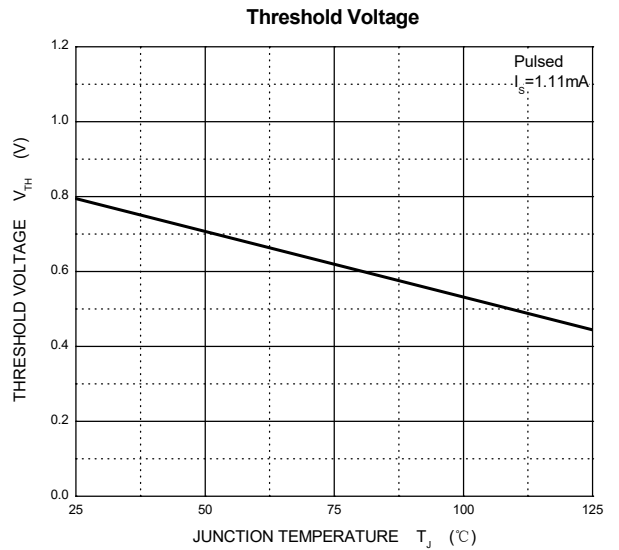
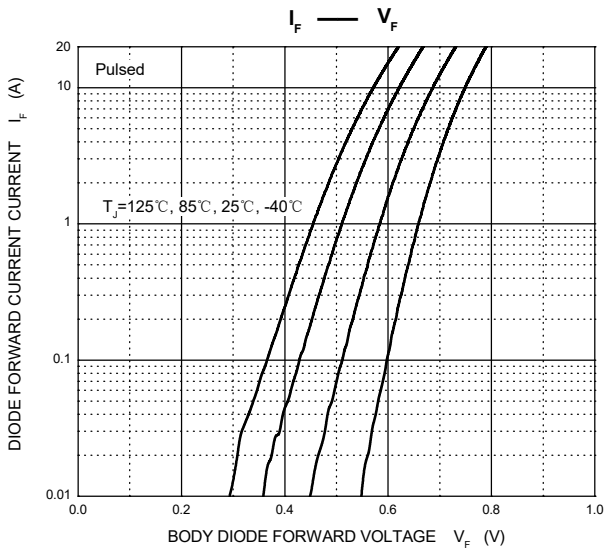
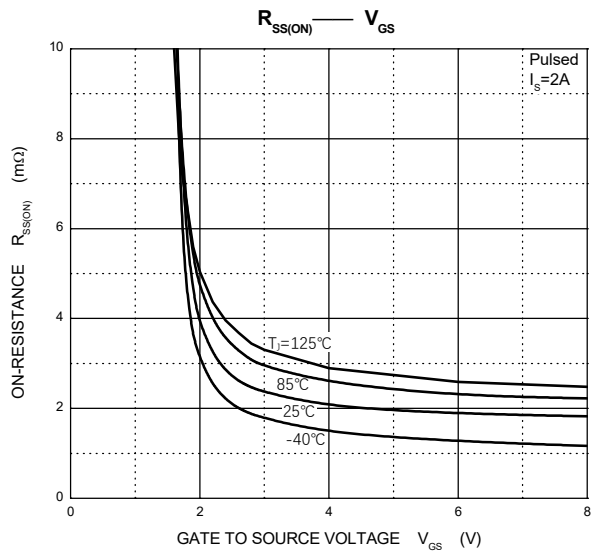
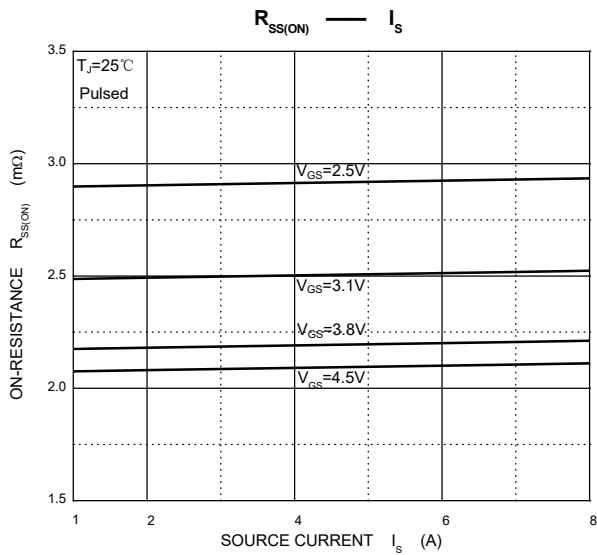
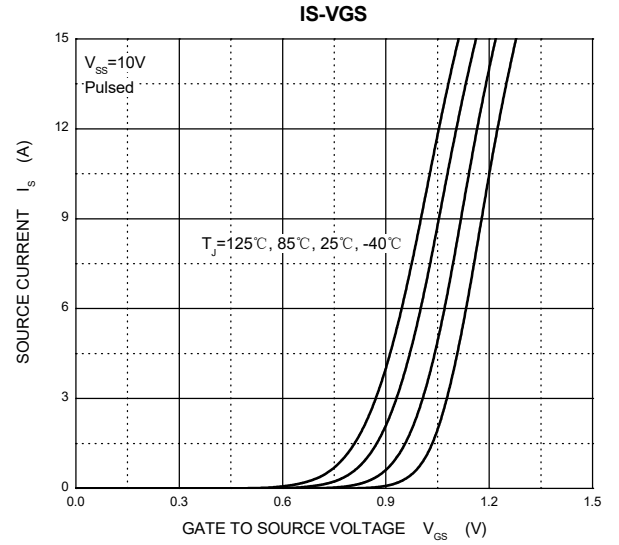
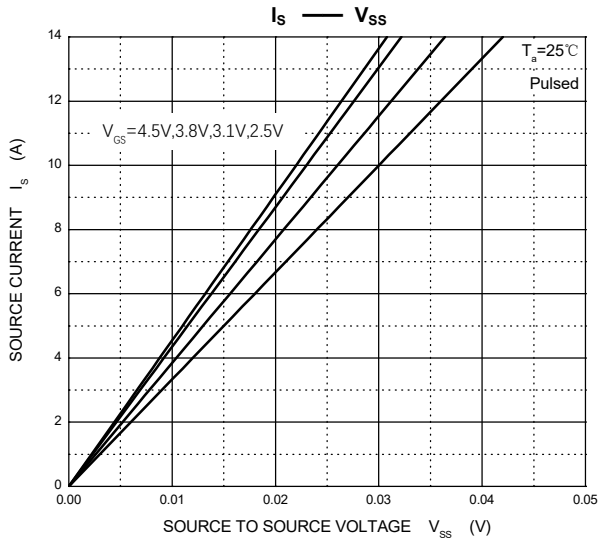
2.  $t = 10\text{ ms}$ , Duty Cycle = 1 %.

3. When FET1 is measured, G2 and S2 are short-circuited.

4. When FET1 is measured, FET2 is biased with  $V_{G2S2}=4.5\text{V}$ .

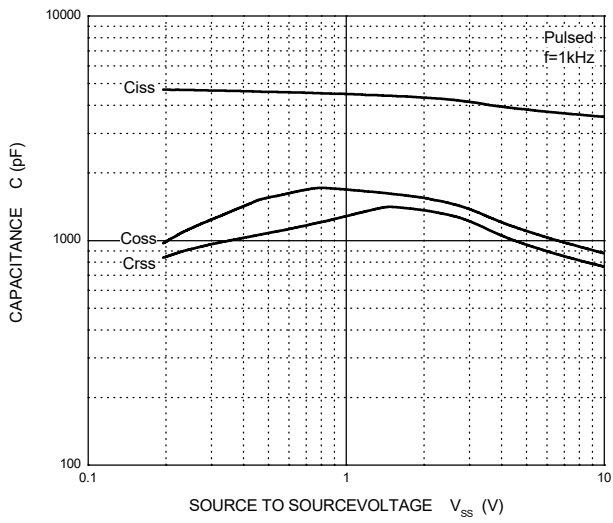


# Typical Characteristics

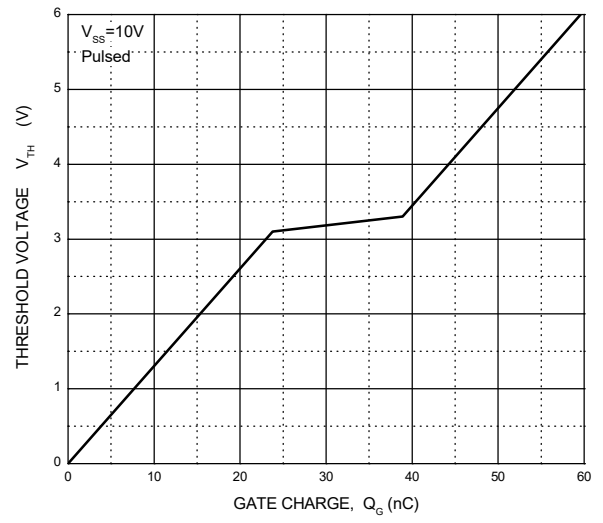


# Typical Characteristics

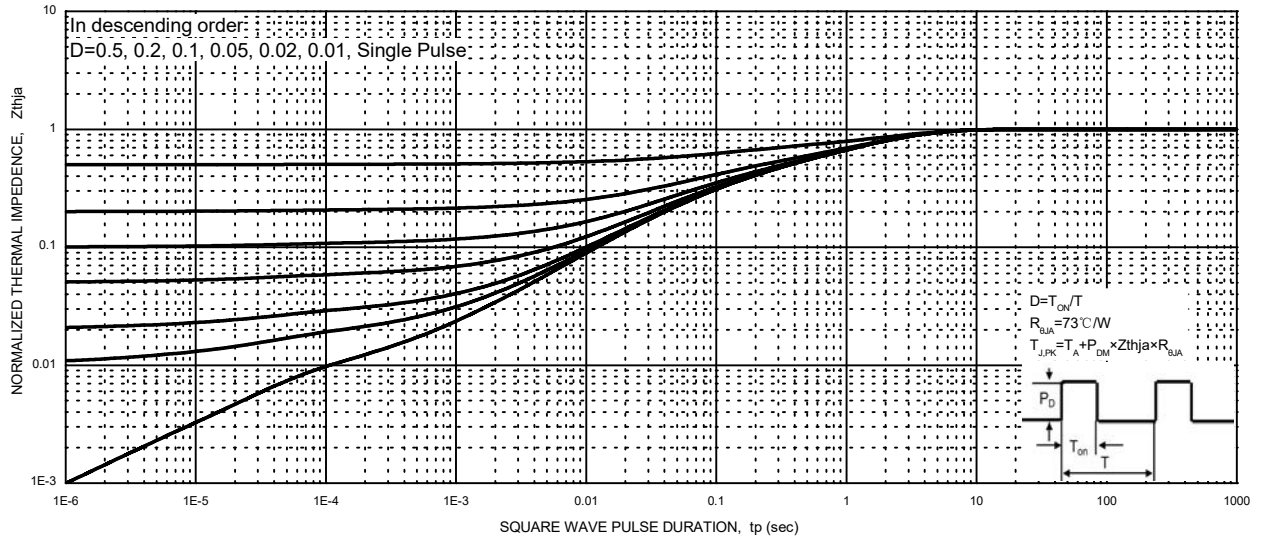
Capacitances



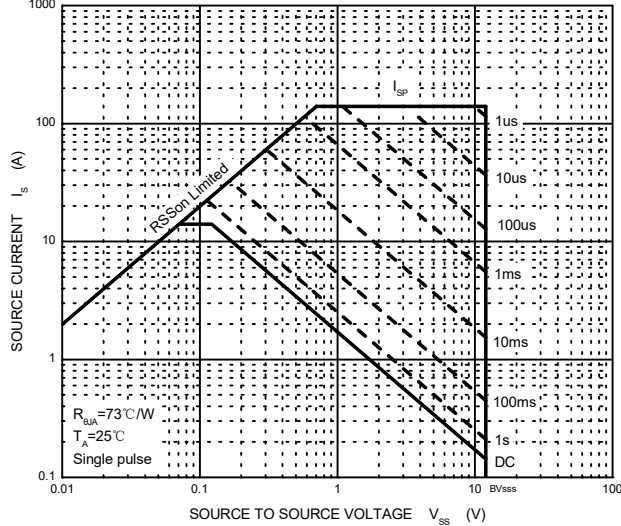
Gate Charge



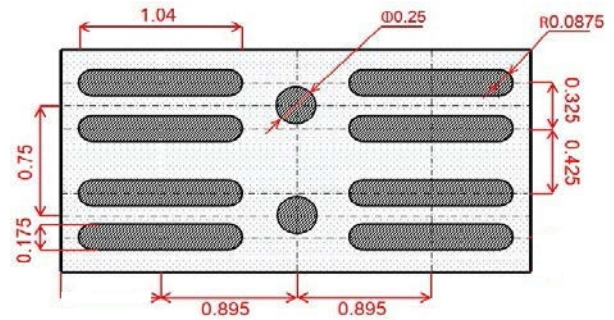
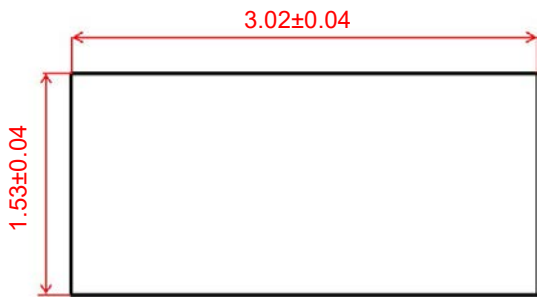
NORMALIZED TRANSIENT THERMAL IMPEDANCE



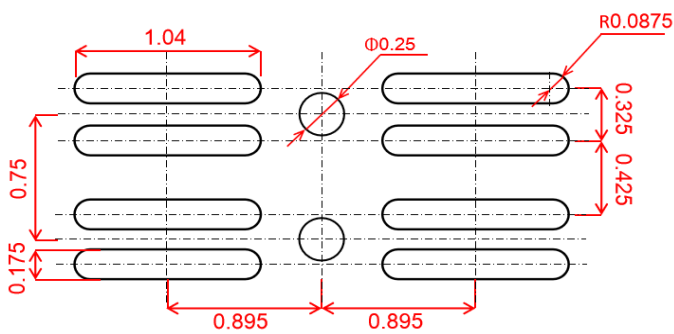
MAXIMUM FORWARD BIASED SAFE OPERATING AREA



## CSPC3015-10 Package Outline Dimensions(Unit:mm)



## CSPC3015-10 Suggested Pad Layout (Unit:mm)



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.050$  mm.
  3. The pad layout is for reference purposes only.

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